



Product Change Notification

110906 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 110906 - 01
Change Title: Intel® Desktop Board DH67GD, Boxed and Bulk
PCN 110906-01, Product Material
Replace PWM CONTROLLER
Reason for Revision: Add CPU Socket Cover change
Date of Publication: August 10, 2011

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Aug 26, 2011
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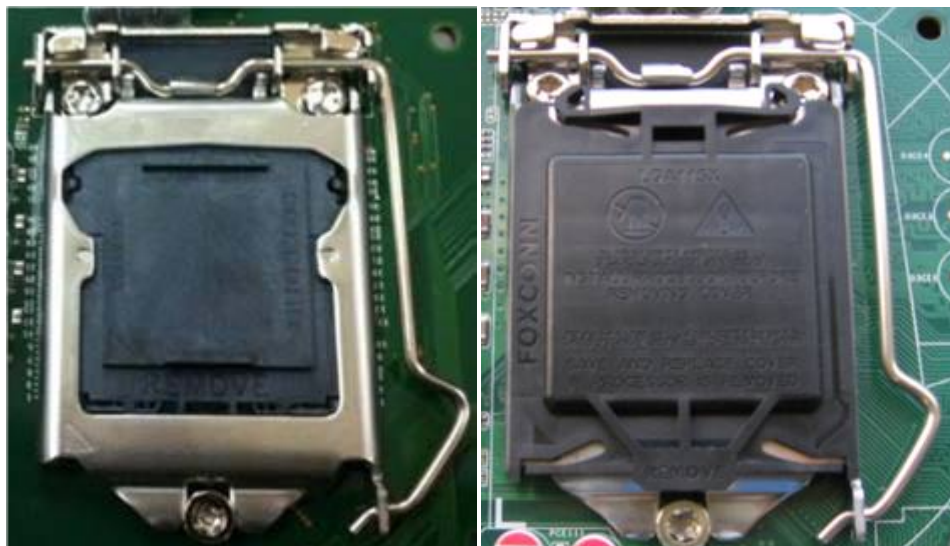
Description of Change to the Customer:

Reason for Revision: Add CPU Socket Cover change

1. The Pulse Width Modulation controller CHIL 8104 upgraded from version E4 to E5 to enhance performance.
2. The CPU socket cover will be changed to the ILM version.

Current socket with PNP cover

New socket with ILM cover



Customer Impact of Change and Recommended Action:

This change has been thoroughly evaluated to ensure that there are no quality, reliability or functional implications to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change AA	Post Change AA
BOXDH67GDB3	915085	G10206-207	G10206-208
BLKDH67GDB3	915086	G10206-207	G10206-208

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
August 4, 2011	00	Originally Published PCN
August 10, 2011	01	Add CPU Socket Cover change